

# Specification of Thermoelectric Module

## TEHC1-24127

### Description

The 241 couples, 62 mm × 62 mm size single module which is made of our high performance ingot to achieve superior cooling performance and 74 °C or larger delta Tmax, is designed for superior cooling and heating applications. Beyond the standard below, we can design and manufacture the custom made module according to your special requirements.

### Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

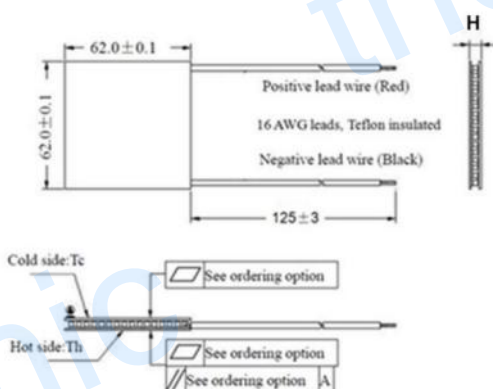
### Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

### Performance Specification Sheet

Th(°C)	27	50	Hot side temperature at environment: dry air, N <sub>2</sub>
DT <sub>max</sub> (°C)	74	83	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side
U <sub>max</sub> (Voltage)	31.8	34.2	Voltage applied to the module at DT <sub>max</sub>
I <sub>max</sub> (amps)	25.2	25.2	DC current through the modules at DT <sub>max</sub>
Q <sub>Cmax</sub> (Watts)	511.3	557.6	Cooling capacity at cold side of the module under DT=0 °C
AC resistance(ohms)	0.95	1.05	The module resistance is tested under AC
Tolerance (%)	± 10		For thermal and electricity parameters

### Geometric Characteristics Dimensions in millimeters



### Ordering Option

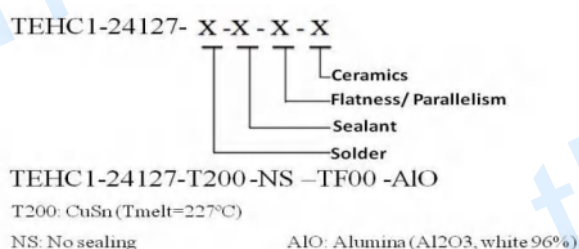
Suffix	Thickness (mm)	Flatness/ Parallelism (mm)	Lead wire length(mm) Standard/Optional length
TF	0:3.8±0.1	0:0.12/0.12	125±3/Specify
TF	1:3.8±0.05	1:0.06/0.06	125±3/Specify

Eg. TF00: Thickness 3.8±0.1(mm) and Flatness 0.12/0.12(mm)

### Manufacturing Options

- |   |                                     |
|---|-------------------------------------|
| <b>A. Solder:</b>                                       | <b>B. Sealant:</b>                  |
| 1. T100: BiSn (Tmelt=138°C)                             | 1. NS: No sealing (Standard)        |
| 2. T200: CuAgSn (Tmelt = 217°C)                         | 2. SS: Silicone sealant             |
| 3. T240: SbSn (Tmelt = 240°C)                           | 3. EPS: Epoxy sealant               |
| <b>C. Ceramics:</b>                                     | <b>D. Ceramics Surface Options:</b> |
| 1. Alumina (Al <sub>2</sub> O <sub>3</sub> , white 96%) | 1. Blank ceramics (not metalized)   |
| 2. Aluminum Nitride (AlN)                               | 2. Metalized                        |

### Naming for the Module



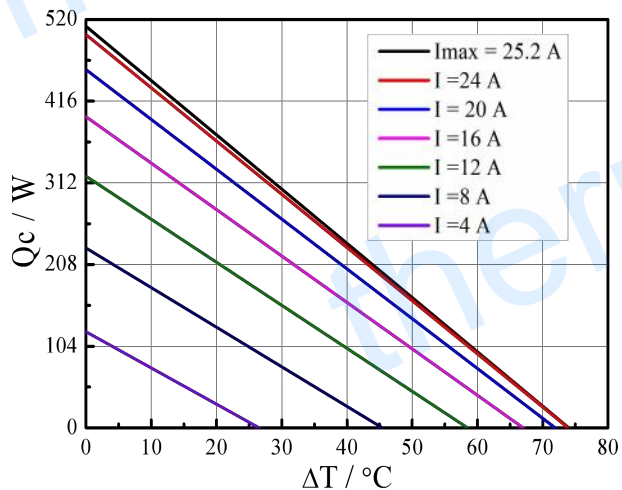
Creative technology with fine manufacturing processes provides you the reliable and quality products

Tel: +86-791-88198288 Fax: +86-791-88198308 Email: [sales@thermonamic.com.cn](mailto:sales@thermonamic.com.cn) Web Site: [www.thermonamic.com.cn](http://www.thermonamic.com.cn)

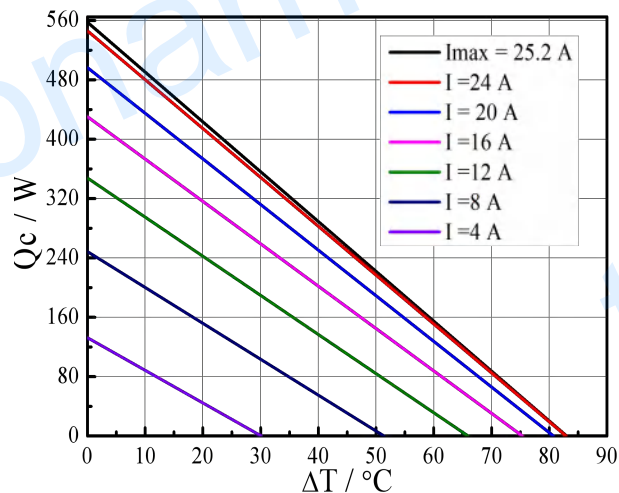
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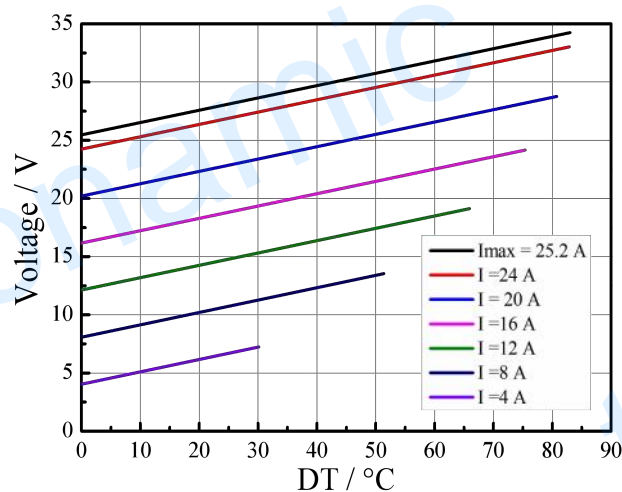
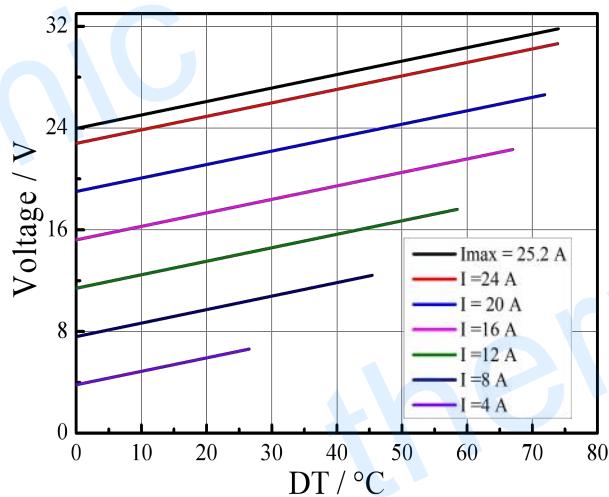
## Performance Curves at Th=27 °C



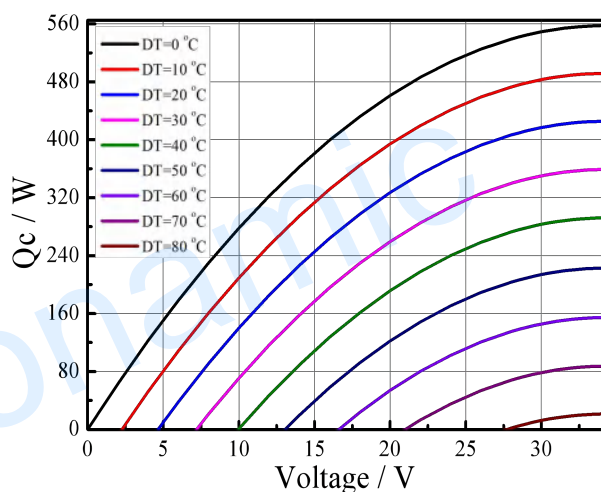
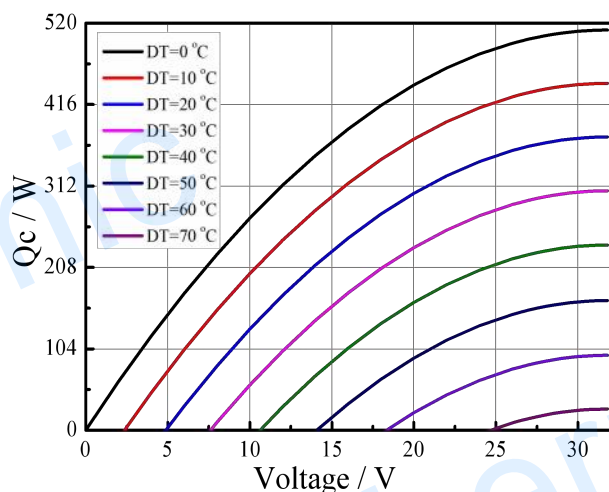
## Performance Curves at Th=50 °C



Standard Performance Graph  $Q_c = f(\Delta T)$



Standard Performance Graph  $V = f(\Delta T)$

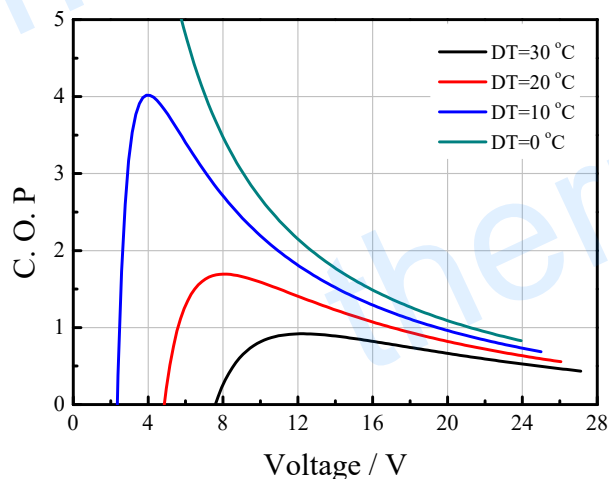


Standard Performance Graph  $Q_c = f(V)$

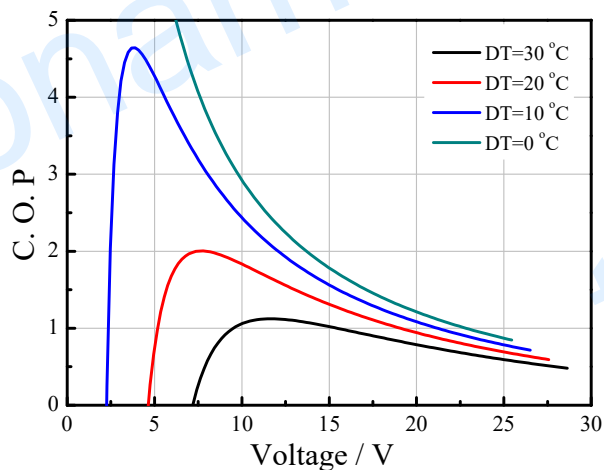
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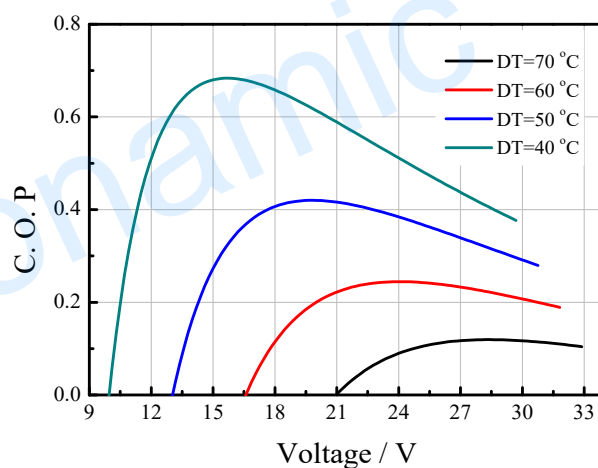
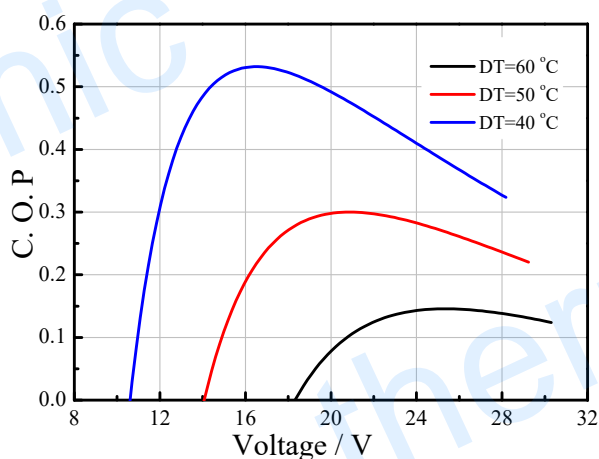
### Performance Curves at Th=27 °C



### Performance Curves at Th=50 °C



Standard Performance Graph COP = f(V) of  $\Delta T$  ranged from 0 to 30 °C



Standard Performance Graph COP = f(V) of  $\Delta T$  ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power  $Q_c$ /Input power ( $V \times I$ ).

### Operation Cautions

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Storage module below 100 °C
- Operation below  $I_{max}$  or  $V_{max}$
- Work under DC